

PATENT ASSIGNMENT

Electronic Version v1.1
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SUBMISSION TYPE:	NEW ASSIGNMENT										
NATURE OF CONVEYANCE:	ASSIGNMENT										
CONVEYING PARTY DATA											
<table border="1" style="width:100%; border-collapse: collapse;"> <thead> <tr> <th style="width:70%;">Name</th> <th>Execution Date</th> </tr> </thead> <tbody> <tr> <td>Jae Gon Lee</td> <td>02/13/2008</td> </tr> <tr> <td>Elgin Kiok Boone Quek</td> <td>02/13/2008</td> </tr> <tr> <td>Young Way Teh</td> <td>02/18/2008</td> </tr> <tr> <td>Wenzhi Gao</td> <td>02/13/2008</td> </tr> </tbody> </table>		Name	Execution Date	Jae Gon Lee	02/13/2008	Elgin Kiok Boone Quek	02/13/2008	Young Way Teh	02/18/2008	Wenzhi Gao	02/13/2008
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Wenzhi Gao	02/13/2008										
RECEIVING PARTY DATA											
Name:	CHARTERED SEMICONDUCTOR MANUFACTURING LTD.										
Street Address:	60 Woodlands Industrial Park D										
Internal Address:	Street 2										
City:	Singapore 738406										
State/Country:	SINGAPORE										
PROPERTY NUMBERS Total: 1											
<table border="1" style="width:100%; border-collapse: collapse;"> <thead> <tr> <th style="width:30%;">Property Type</th> <th>Number</th> </tr> </thead> <tbody> <tr> <td>Application Number:</td> <td>12040777</td> </tr> </tbody> </table>		Property Type	Number	Application Number:	12040777						
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CORRESPONDENCE DATA											
Fax Number:	(408)738-0881										
<i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i>											
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Email:	efiling@ishimarulaw.com										
Correspondent Name:	Mikio Ishimaru										
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Address Line 4:	Sunnyvale, CALIFORNIA 94087										
ATTORNEY DOCKET NUMBER:	CS2007/026										
NAME OF SUBMITTER:	Mikio Ishimaru										
Total Attachments: 5											

CH \$40.00 12040777

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ASSIGNMENT

WHEREAS, the undersigned (hereinafter termed Assignor(s)) has/have invented certain new and useful improvements in

INTEGRATED CIRCUIT SYSTEM FOR SUPPRESSING SHORT CHANNEL EFFECTS

for which a United States patent application has been executed on or before the date of this assignment.

WHEREAS, CHARTERED SEMICONDUCTOR MANUFACTURING LTD., a Corporation of the Republic of Singapore, having a place of business at 60 Woodlands Industrial Park D, Street 2, Singapore 738406, Singapore (hereinafter termed Assignee), is desirous of acquiring the entire right, title and interest in and to said application and said invention and improvements thereon, and in and to Letters Patents thereon when granted in the United States and foreign countries.

NOW, THEREFORE, for good and valuable consideration received by said Assignor(s) from said Assignee, the receipt of which is hereby acknowledged by said Assignor(s):

1. Said Assignor(s) does hereby sell, assign, transfer and convey unto said Assignee, the entire right, title and interest in and to said application and said invention and in and to any and all improvements on said invention and in and to any and all improvements on said invention heretofore or hereafter made or acquired by said Assignor(s); and in and to any and all Letters Patent on said invention and/or said improvements that may be granted in the United States or any foreign country, including each and every Letters Patent granted on any application which is a division, continuation, substitution, renewal, or continuation-in-part of any said application, and in and to each and every reissue or extension of said Letters Patent.
2. Said Assignor(s) hereby covenants and agrees to cooperate with said Assignee where said Assignee may enjoy to the fullest extent the right, title and interest herein conveyed. Such cooperation shall include (a) prompt execution of all papers (prepared at the expense of Assignee) which are deemed necessary or desirable by Assignee to perfect in it the right, title and interest herein conveyed, (b) prompt execution of all petitions, oaths, specifications or other papers (prepared at the expense of Assignee) which are deemed necessary or desirable by assignee for prosecuting said application, for filing and prosecuting divisional, continuation, substitution, renewal, continuation-in-part, or additional applications in the United States and/or foreign countries covering said invention and/or said improvements, for filing and prosecuting applications for reissuance of letters patent included herein, or for interference proceedings involving said invention and/or said improvements and (c) prompt assistance and cooperation in the prosecution of interference proceedings involving said invention and/or said improvements and in the adjudication of said Letters Patent, particularly by the disclosure of facts and the production of evidence relating to said invention and/or said improvements, provided the expenses which may be incurred by said Assignor(s) in lending such assistance and cooperation shall be paid by the Assignee.
3. The terms, covenants and conditions of this assignment shall inure to the benefit of said Assignee, its successors, assigns and/or other legal representatives and shall be binding upon said Assignor(s), his/her heirs, legal representatives and assigns.
4. Said Assignor(s) hereby warrants and represents that he/she has not entered into any assignment, contract or understanding in conflict herewith.

IN WITNESS WHEREOF, the said Assignor has executed and delivered this instrument on the date set forth below.

Jae Gon Lee

Jae Gon Lee

[Signature]

Witness Signature

~~13 Feb 08~~ TAN SHYUE SEN

Print Witness Name

13 Feb 08

Date

13 Feb 08

Date

~~13 Feb 08~~ *[Signature]*

Witness Signature


TEO LEE WEI


Print Witness Name

13 Feb 08

Date

IN WITNESS WHEREOF, the said Assignor has executed and delivered this instrument on the date set forth below.




Elgin Kiok Boone Quek


Witness Signature
TAN SHYUE SENG

Print Witness Name
13 Feb 08

Date

13/2/08

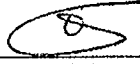
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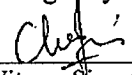
Witness Signature
TEO LEE WEE

Print Witness Name
13 Feb 08

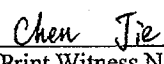
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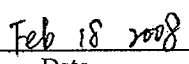


Young Way Teh


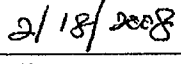
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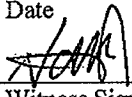


Chen Jie
Print Witness Name




Feb 18 2008
Date

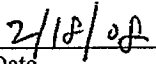


2/18/2008
Date


Witness Signature




Kim Nam Sung
Print Witness Name

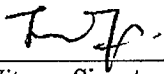


2/18/08
Date

IN WITNESS WHEREOF, the said Assignor has executed and delivered this instrument on the date set forth below.



Wenzhi Gao



Witness Signature

TAN SHYNE SENG


Print Witness Name

13 FEB 08

Date

13/02/08

Date



Witness Signature

TED LEE WEI

Print Witness Name

13 Feb 08

Date